

Docket No. 246245US0

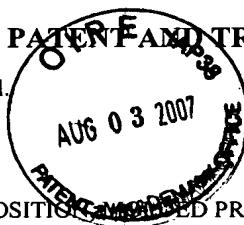
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Haruhisa MASUDA, et al.

SERIAL NO: 10/728,991

FILED: December 8, 2003

FOR: THERMOPLASTIC POLYMER COMPOSITION, A MOLDED PRODUCT, AND MULTILAYER STRUCTURE



GAU: 1711

EXAMINER: MULLIS, J.C.

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the reference(s) cited in the attached Japanese Notification of Rejection Reasons and References and listed on the attached form PTO-1449. Copies of the listed reference(s) are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language reference(s). Reference No. 1 of the Japanese Notification of Rejection Reasons and References is already of record.
- ☒ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030.

Respectfully submitted,

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MAIER & NEUSTADT, P.C.  
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22850

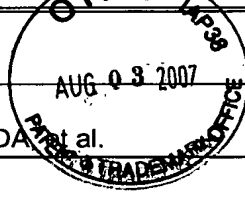
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08/06/2007 JADD01 00000009 10728991

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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. <b>246245US0</b>		SERIAL NO. <b>10/728,991</b>	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT <b>Haruhisa MASUDA et al.</b>			
				FILING DATE <b>December 8, 2003</b>		GROUP <b>1711</b>	



U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS						
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO	01-315442	12/20/1989	Japan (with English abstract)		
	AP	08-085570	04/02/1996	Japan (with English abstract)		
	AQ	08-081601	03/26/1996	Japan (with English abstract)		
	AR	2002-036448	02/05/2002	Japan (with English abstract)		
	AS	2002-241619	08/28/2002	Japan (with English abstract)		
	AT	03-277642	12/19/1991	Japan (with English abstract)		
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)		
	AW	
	AX	
	AY	
	AZ	

☐ Additional References sheet(s) attached

Examiner	Date Considered
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\*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.